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HIGH ISOLATION SPDT NON-REFLECTIVE SWITCH, DC - 6 GHz

Typical Applications

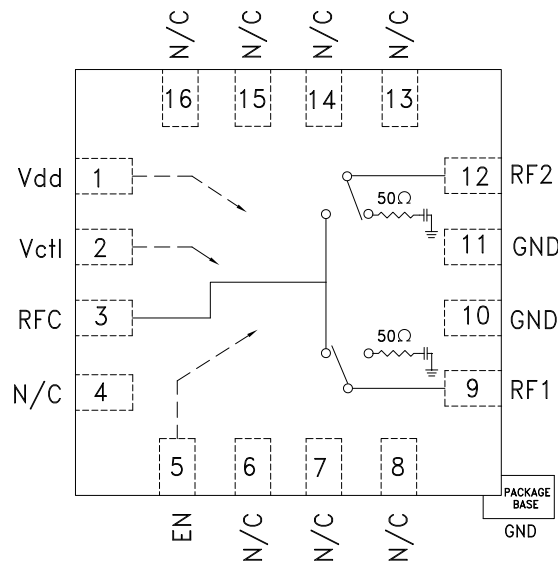
The HMC849LP4CE is ideal for:

- Cellular/4G Infrastructure
- WiMAX, WiBro & Fixed Wireless
- Automotive Telematics
- Mobile Radio
- Test Equipment

Features

- High Isolation: up to 60 dB
- Single Positive Control: 0/+3V to +5V
- High Input IP3: +52 dBm
- Non-Reflective Design
- “All Off” State
- 16 Lead 4x4 mm QFN Package: 16 mm²

Functional Diagram



General Description

The HMC849LP4CE is a high isolation non-reflective DC to 6 GHz GaAs pHEMT SPDT switch in a low cost leadless surface mount package. The switch is ideal for cellular/WiMAX/4G Infrastructure applications yielding up to 60 dB isolation, low 0.8 dB insertion loss and +52 dBm input IP3. Power handling is excellent up through the 5 - 6 GHz WiMAX band with the switch offering a P1dB compression point of +31 dBm. On-chip circuitry allows a single positive voltage control of 0/+3V or 0/+5V at very low DC currents. An enable input (EN) set to logic high will put the switch in an “all off” state.

Electrical Specifications, $T_A = +25\text{ }^\circ\text{C}$, $V_{ctl} = 0/V_{dd}$, $V_{dd} = +3V$ to $+5V$, 50 Ohm System

| Parameter | Frequency | Min. | Typ. | Max. | Units |
|--|----------------|----------------------------------|------|------|-------|
| Insertion Loss | DC - 2.0 GHz | | 0.8 | 1.3 | dB |
| | 2.0 - 4.0 GHz | | 1.0 | 1.5 | dB |
| | 4.0 - 6.0 GHz | | 1.7 | 2.5 | dB |
| Isolation (RFC to RF1/RF2) | DC - 2.0 GHz | 53 | 60 | | dB |
| | 2.0 - 4.0 GHz | 48 | 55 | | dB |
| | 4.0 - 6.0 GHz | 40 | 52 | | dB |
| Return Loss (On State) | DC - 4.0 GHz | | 17 | | dB |
| | 4.0 - 6.0 GHz | | 13 | | dB |
| Return Loss (Off State) | DC - 6.0 GHz | | 15 | | dB |
| Input Power for 1 dB Compression | 0.35 - 4.0 GHz | +3V | 29 | 30 | dBm |
| | | +5V | 34 | 35 | dBm |
| Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone) | DC - 6.0 GHz | | 52 | | dBm |
| Switching Speed | DC - 4.0 GHz | tRISE, tFALL (10/90% RF) | 80 | | ns |
| | | tON, tOFF (50% CTL to 10/90% RF) | 150 | 600 | ns |

For price, delivery and to place orders: Hittite Microwave Corporation, 2 Elizabeth Drive, Chelmsford, MA 01824

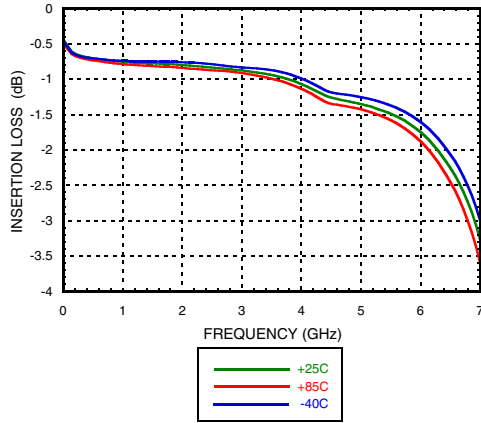
Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

Application Support: Phone: 978-250-3343 or apps@hittite.com

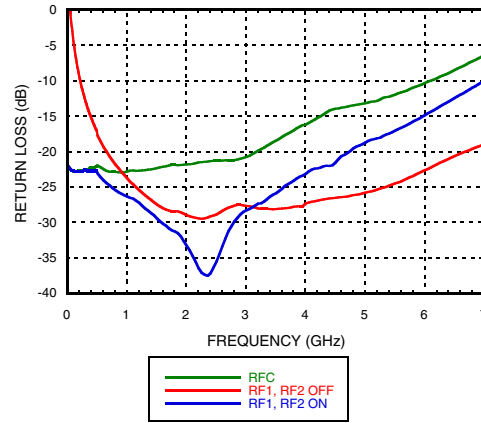


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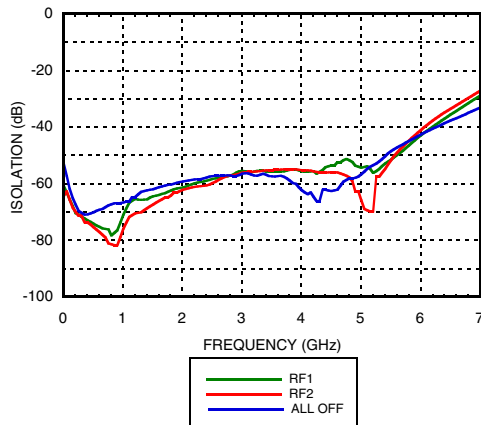
Insertion Loss



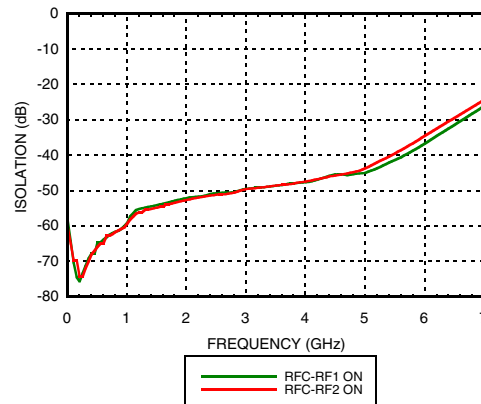
Return Loss [1]



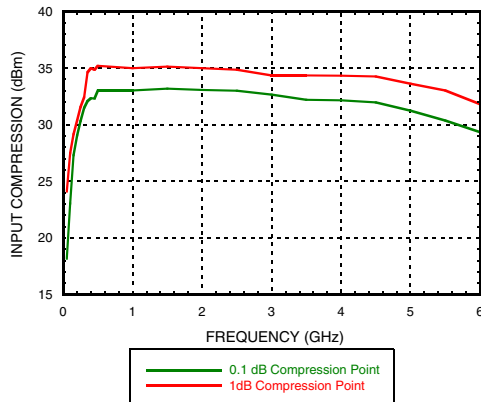
Isolation Between Ports RFC and RF1 / RF2



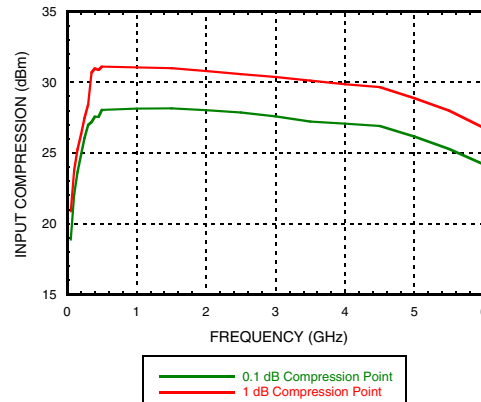
Isolation Between Ports RF1 and RF2



0.1 and 1 dB Input Compression Point, Vdd = 5V, Linear



0.1 and 1 dB Input Compression Point, Vdd = 3V, Linear



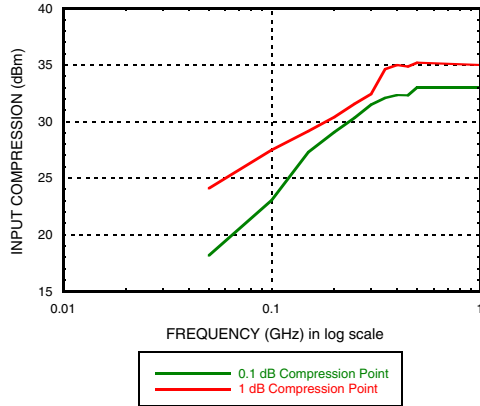
[1] RFC is reflective in "all off" state.



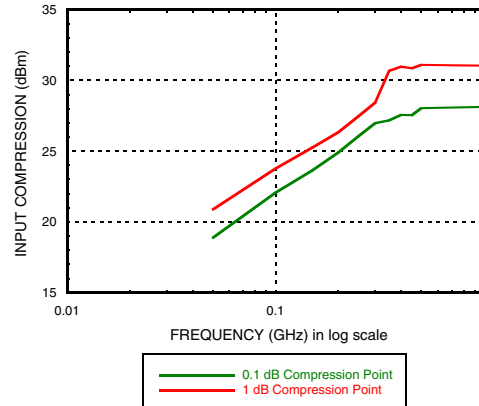
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SWITCHES - SPDT - SMT

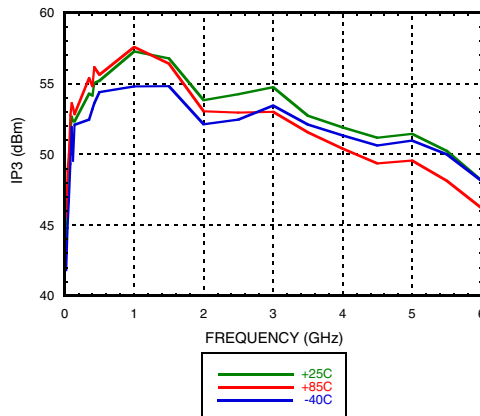
0.1 and 1 dB Input Compression Point, Vdd = 5V



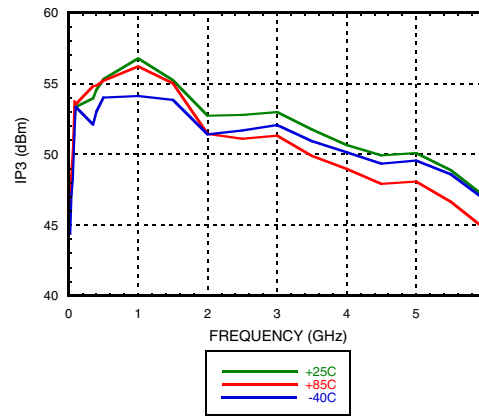
0.1 and 1 dB Input Compression Point, Vdd = 3V



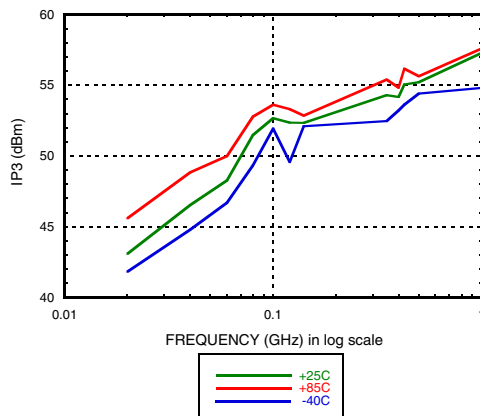
Input Third Order Intercept Point, Vdd = 5V, Linear



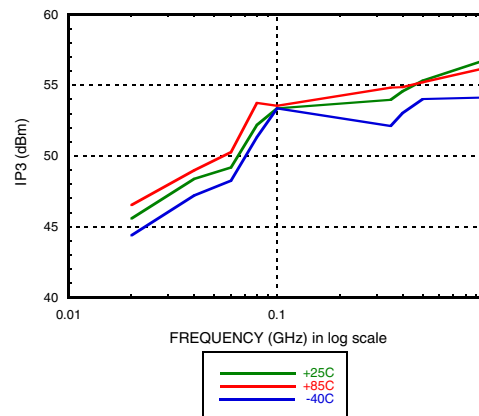
Input Third Order Intercept Point, Vdd = 3V, Linear



Input Third Order Intercept Point, Vdd = 5V



Input Third Order Intercept Point, Vdd = 3V




**HIGH ISOLATION SPDT
NON-REFLECTIVE SWITCH, DC - 6 GHz**
Absolute Maximum Ratings

| | |
|---|--|
| Bias Voltage (Vdd) | 7V |
| Control Voltage (Vctl, EN) | -1V to Vdd +1V |
| RF Input Power * | 30.60 / 33 dBm 26.4 dBm |
| | Through Path 3V/5V Termination Path 3V/5V |
| Channel Temperature | 150 °C |
| Continuous Pdiss (T = 85 °C) (derate 17.6 mW/°C for through path, and 6.8 mW/°C for termination path above 85 °C) | 1.144 W 0.441 W |
| | Through Path Termination Path |
| Thermal Resistance (channel to package bottom) | 56.8 °C/W 147.3 °C/W |
| | Through Path Termination Path |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |
| ESD Sensitivity (HBM) | Class 1A |

* The RF input power is quite lower than the breakdown power levels. Hence, the only concern with this product is the thermal limit.



**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

Bias Voltage & Current

| Vdd (V) | Idd (Typ.) (mA) |
|---------|-----------------|
| 3 | 0.80 |
| 5 | 0.85 |

Digital Control Voltages

| State | Bias Condition |
|-------|----------------------------------|
| Low | 0 to +0.8 Vdc @ <1 μA Typical |
| High | +2.0 to +5.0 Vdc @ 30 μA Typical |

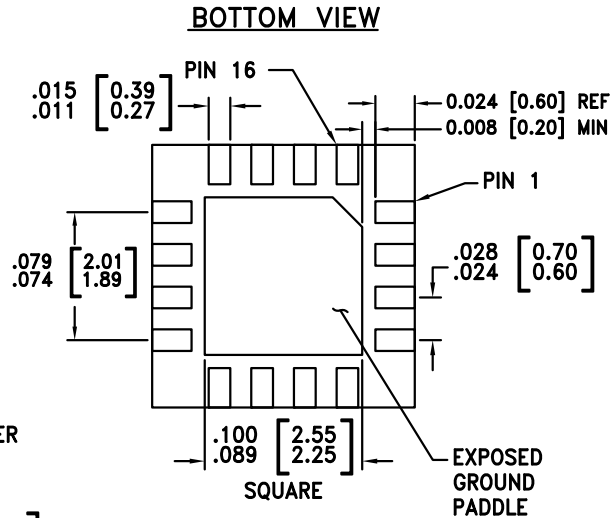
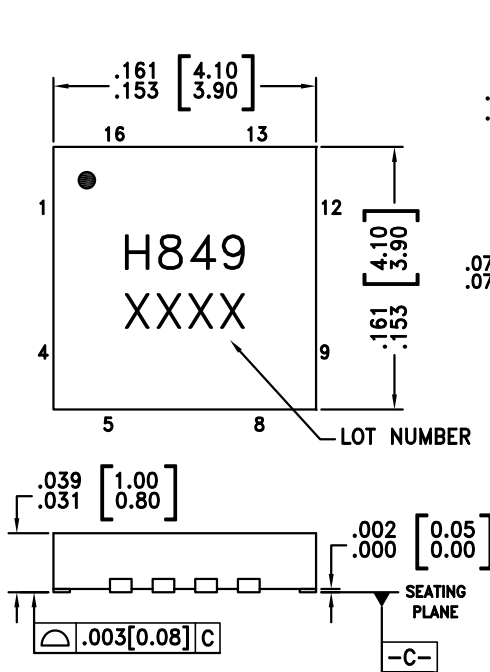
Truth Table

| Control Input | | Signal Path State | |
|---------------|------|-------------------|-----------|
| Vctl | EN | RFC - RF1 | RFC - RF2 |
| Low | Low | OFF | ON |
| High | Low | ON | OFF |
| Low | High | OFF | OFF |
| High | High | OFF | OFF |



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Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

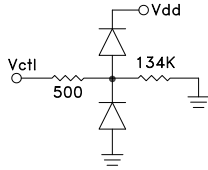
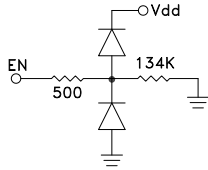

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[1] |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC849LP4CE | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 ^[2] | H849 XXXX |

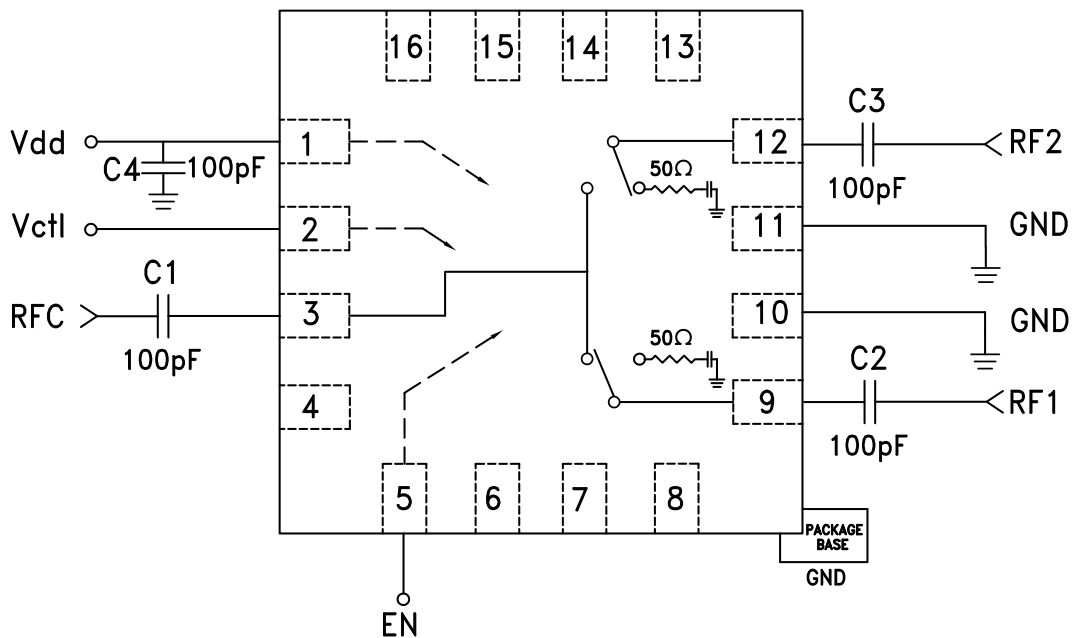
[1] 4-Digit lot number XXXX

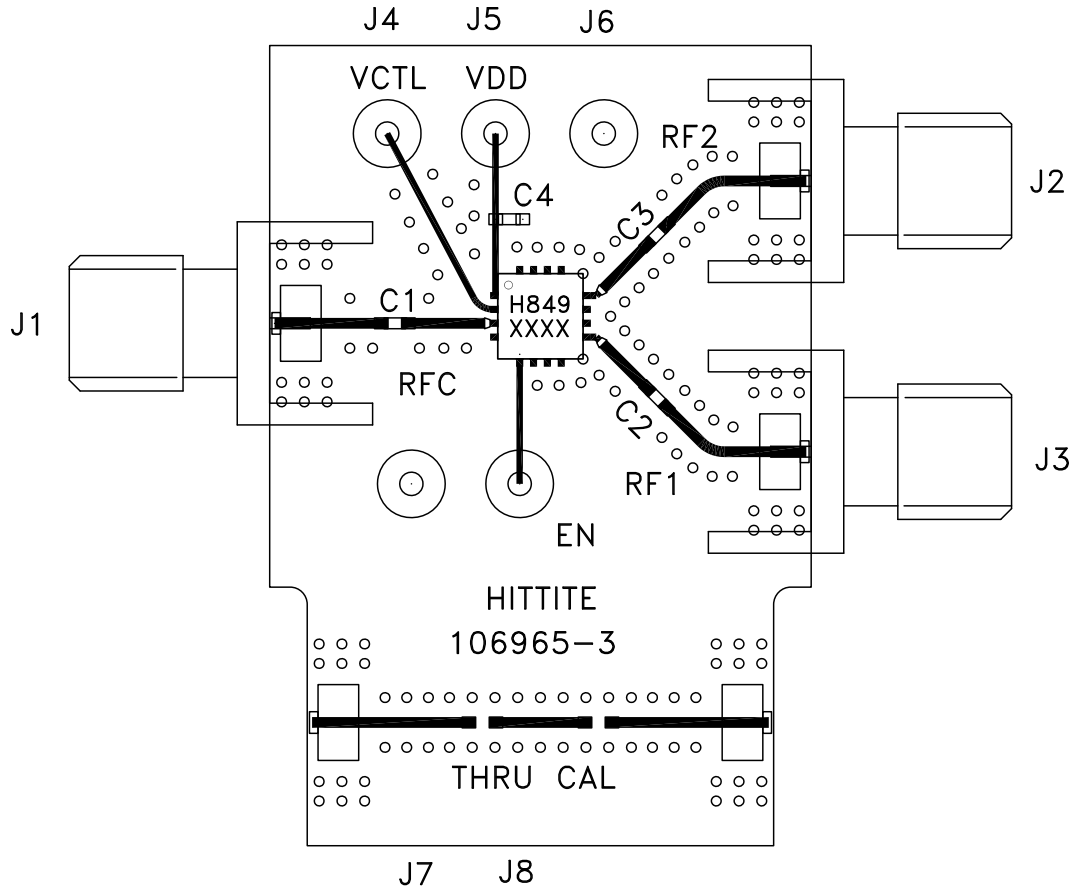
[2] Max peak reflow temperature of 260 °C

Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|----------------------------|---------------|--|---|
| 1 | Vdd | Supply Voltage. | |
| 2 | Vctl | Control input. See truth and control voltage tables. |  |
| 3, 9, 12 | RFC, RF1, RF2 | These pins are DC coupled and matched to 50 Ohms. Blocking capacitors are required. | |
| 4, 6, 7, 8, 13, 14, 15, 16 | N/C | The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally. | |
| 5 | EN | Enable. See truth and control voltage tables. |  |
| 10, 11 | GND | Package bottom must also be connected to PCB RF ground. |  |

Application Circuit



Evaluation PCB

List of Materials for Evaluation PCB 106975 [1]

| Item | Description |
|---------|-----------------------------|
| J1 - J3 | PC Mount SMA RF Connector |
| J4 - J8 | DC Pin |
| C1 - C4 | 100 pF Capacitor, 0402 Pkg. |
| U1 | HMC849LP4CE SPDT Switch |
| PCB [2] | 106965 Evaluation PCB |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25FR

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 Ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.



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Notes: